Unit in mm

7.62 ± 0.25

11-10C4

11-10C4

TOSHIBA Photocoupler GaAlAs Ired & Photo-IC

# **TLP250**

**Transistor Inverter** Inverter For Air Conditioner **IGBT Gate Drive** Power MOS FET Gate Drive

The TOSHIBA TLP250 consists of a GaAlAs light emitting diode and a integrated photodetector.

This unit is 8-lead DIP package.

TLP250 is suitable for gate driving circuit of IGBT or power MOS FET.

- Input threshold current: IF=5mA(max.)
- Supply current (ICC): 11mA(max.)
- Supply voltage (V<sub>CC</sub>): 10-35V
- Output current (IO): ±1.5A (max.)
- Switching time (t<sub>pLH</sub>/t<sub>pHL</sub>): 0.5µs(max.)
- Isolation voltage: 2500V<sub>rms</sub>(min.)
- UL recognized: UL1577, file No.E67349
- Option(D4)

VDE Approved: DIN EN60747-5-2

Maximum Operating Insulation Voltage: 890 VPK

Please designate "Option(D4)"

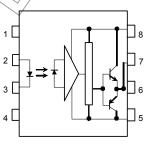
(Note): When a EN60747-5-2 approved type is needed,

Highest Permissible Over Voltage

: 4000VPK Weight: 0.54 g (typ.)

#### Pin Configuration (top view)

TOSHIBA



1: N.C. 2: Anode 5 : GND

3 : Cathode

6 : VO (Output)

4 : N.C.

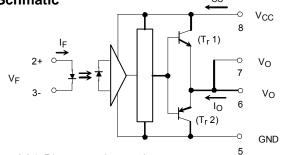
7 : V<sub>O</sub> 8 : V<sub>CC</sub>

### **Truth Table**

		Tr1	Tr2
Input LED	On	On	Off
	Off	Off	On



1



A 0.1µF bypass capcitor must be connected between pin 8 and 5 (See Note 5).

#### Absolute Maximum Ratings (Ta = 25°C)

	Characteristic	Symbol	Rating	Unit	
	Forward current	l <sub>F</sub>	20	mA	
	Forward current derating (Ta ≥ 70°C)	ΔI <sub>F</sub> / ΔTa	-0.36	mA / °C	
딕	Peak transient forward curent	I <sub>FPT</sub>	1	А	
	Reverse voltage		V <sub>R</sub>	5	V
	Junction temperature		Tj	125	°C
	"H"peak output current (P <sub>W</sub> ≤ 2.5µs,f ≤ 15kHz)	I <sub>OPH</sub>	(-1.5)	> A	
	"L"peak output current (P <sub>W</sub> ≤ 2.5µs,f ≤ 15kHz)	(Note 2)	I <sub>OPL</sub>	+1.5	Α
	Output voltage	(Ta ≤ 70°C)	Yo	<b>//</b> 35	V
	Output voltage	(Ta = 85°C)	VO	24	V
Detector	Supply voltage	(Ta ≤ 70°C)	VGC	35	V
۵	Supply voltage	(Ta = 85°C)	VCC	24	V
	Output voltage derating (Ta ≥ 70°C)		ΔV <sub>O</sub> ν ΔΤα	-0.73	AY.c
	Supply voltage derating (Ta ≥ 70°C)		ΔV <sub>CC</sub> / ΔTa	-0.73	1/ NJ.6
	Junction temperature		\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	125	∵°C
Oper	ating frequency	(Note 3)	/ )) f		kHz
Operating temperature range			T <sub>opr</sub>	-20~85	///°C
Storage temperature range			> T <sub>stg</sub>	=55~125	°C
Lead	Lead soldering temperature (10 s)			260	°C
Isola	tion voltage (AC, 1 min., R.H.≤ 60%)	BVS	2500	Vrms	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Pulse width P<sub>W</sub> ≤ 1µs, 300pps

Note 2: Exporenential waveform

Note 3: Exporenential waveform,  $lop_H \le -1.0A (\le 2.5 \mu s)$ ,  $lop_L \le +1.0A (\le 2.5 \mu s)$ 

Note 4: Device considerd a two terminal device: Pins 1, 2, 3 and 4 shorted together, and pins 5, 6, 7 and 8 shorted together.

Note 5: A ceramic capacitor(0.1µF) should be connected from pin 8 to pin 5 to stabilize the operation of the high gain linear amplifier. Failure to provide the bypassing may impair the switching proparty. The total lead length between capacitor and coupler should not exceed 1cm.

### **Recommended Operating Conditions**

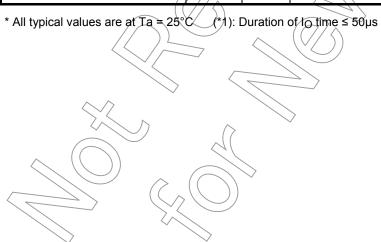
Characteristic		Symbol	Min	Тур.	Ma	ax	Unit
Input current, on (	(Note6)	(I <sub>F(ON)</sub> )	7	8	1	0	mA
Input voltage, off	8	VF(OFF)	0	1	0.	8	V
Supply voltage	>	Vcc	15	1	30	20	V
Peak output current		I <sub>OPH</sub> /I <sub>OPL</sub>	_	1	±0.5		Α
Operating temperature		T <sub>opr</sub>	-20	25	70	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Note 6: Input signal rise time(fall time)<0.5 $\mu$ s.

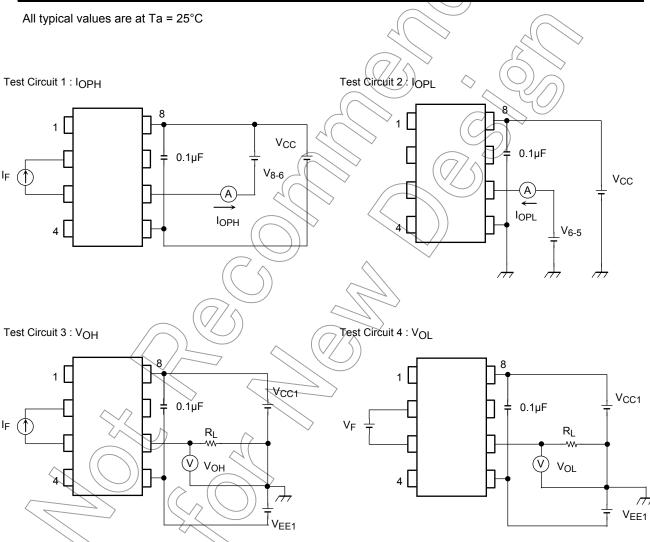
## Electrical Characteristics ( $Ta = -20 \sim 70^{\circ}C$ , unless otherwise specified)

Characte	ristic	Symbol	Test Cir– cuit	Test Condition	Min	Тур.*	Max	Unit	
Input forward voltage	:	V <sub>F</sub>	_	I <sub>F</sub> = 10 mA , Ta = 25°C	_	1.6	1.8	V	
Temperature coefficient forward voltage	ent of	ΔV <sub>F</sub> / ΔTa	_	I <sub>F</sub> = 10 mA	_	-2.0	_	mV / °C	
Input reverse current		I <sub>R</sub>	_	V <sub>R</sub> = 5V, Ta = 25°C	->		10	μА	
Input capacitance		C <sub>T</sub>	_	V = 0 , f = 1MHz , Ta = 25°C	4(	45	250	pF	
Output current	"H" level	I <sub>OPH</sub>	1	$V_{CC} = 30V$ $I_{F} = 10 \text{ mA}$ $V_{8-6} = 4V$	0.5	-1.5	ı	А	
Output current	"L" level	I <sub>OPL</sub>	2	(*1) $I_F = 0$ $V_{6-5} = 2.5$	0.5	2		A	
Output voltage	"H" level	V <sub>OH</sub>	3	$V_{CC1}$ = +15V, $V_{EE1}$ = -15V $R_L$ = 200 $\Omega$ , $I_F$ = 5mA	)11	12.8		V	
Output voltage	"L" level	V <sub>OL</sub>	4	$V_{CC1} = +15V, V_{EE} = -15V$ $R_L = 200\Omega, V_F = 0.8V$	_	-14.2	-12.5	V	
	"H" level	Іссн	_	V <sub>CC</sub> = 30V, I <sub>F</sub> = 10mA Ta = 25°C			\rangle -		
Supply current				V <sub>CC</sub> = 30V, I <sub>F</sub> = 10mA	_	Y	// 11	- mA	
oupply ourion.	"L" level	ICCL	_	$V_{CC} = 30V$ , $I_F = 0mA$ Ta = $25^{\circ}C$	(6)	7.5			
				$V_{CC} = 30V$ , $I_F = 0mA$	$\sqrt{-}$	/ _	11		
Threshold input current	"Output L→H"	I <sub>FLH</sub>		$V_{CC1} = +15V, V_{EE1} = -15V$ $R_L = 200\Omega, V_O > 0V$	<u></u>	1.2	5	mA	
Threshold input voltage	"Output H→L"	V <sub>FHL</sub>		$V_{CC1} = +15V, V_{EE1} = -15V$ $R_L = 200\Omega, V_Q < 0V$	0.8	-	_	٧	
Supply voltage		V <sub>CC</sub> (	(-)		10	_	35	V	
Capacitance (input-output)		C <sub>S</sub>		V <sub>S</sub> = 0 , f = 1MHz Ta = 25℃	_	1.0	2.0	pF	
Resistance(input-output)		Rs	) _	V <sub>S</sub> = 500V , Ta = 25°C R.H.≤ 60%	1×10 <sup>12</sup>	10 <sup>14</sup>	_	Ω	



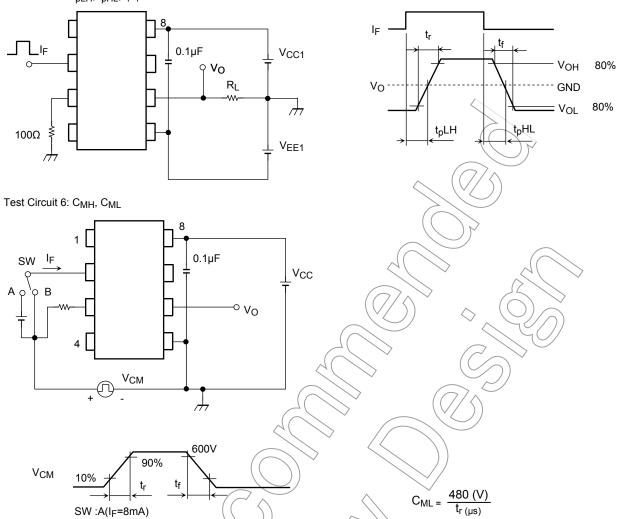
## Switching Characteristics (Ta = $-20 \sim 70^{\circ}\text{C}$ , unless otherwise specified)

Characteristic		Symbol	Test Cir– cuit	Test Condition	Min	Typ.*	Max	Unit
Propagationdelay time	L→H	t <sub>pLH</sub>	- 5	I <sub>F</sub> = 8mA V <sub>CC1</sub> = +15V, V <sub>EE1</sub> = -15V	_	0.15	0.5	μs
	H→L	t <sub>pHL</sub>			_	0.15	0.5	
Output rise time Output fall time		t <sub>r</sub>		$R_L = 200\Omega$		_	_	μο
		t <sub>f</sub>			-(	1	_	
		V <sub>CM</sub> = 600V, I <sub>F</sub> = 8mA V <sub>CC</sub> = 30V, Ta = 25°C	-5000		_	V / µs		
Common mode transier immunity at low level output	nt	C <sub>ML</sub>	0	V <sub>CM</sub> = 600V, I <sub>F</sub> = 0mA V <sub>CC</sub> = 30V, Ta = 25°C	5000		_	V / µs



Test Circuit 5: t<sub>pLH</sub>, t<sub>pHL</sub>, t<sub>r</sub> t<sub>f</sub>

 $V_{O}$ 



 $C_{ML}(C_{MH})$  is the maximum rate of rise (fall) of the common mode voltage that can be sustained with the output voltage in the low (high) state.

 $\mathsf{C}_{\mathsf{MH}}$ 

C<sub>H</sub>/

26V



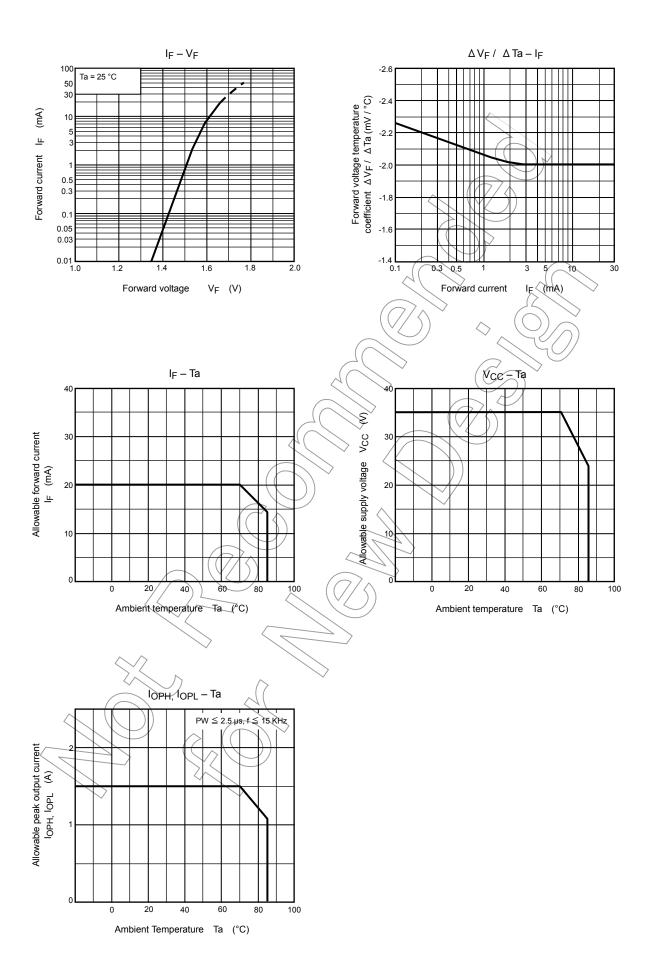
3V

SW :B(I<sub>F</sub>=0)

480 (V)

t<sub>f (µs)</sub>

C<sub>MH</sub> =



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